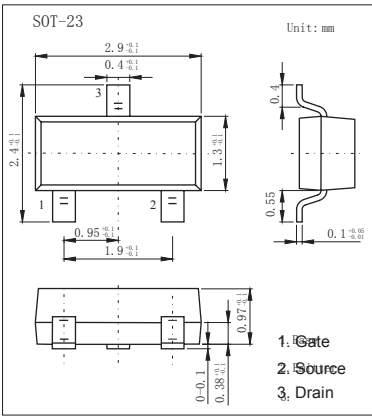
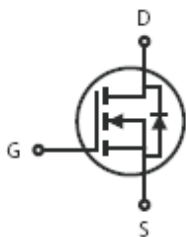


N-Channel Enhancement MOSFET

SI2300 (KI2300)

■ Features

- $V_{DS}=20V$
- $I_D=5.0A$
- $R_{DS(ON)}=25m\Omega @V_{GS}=4.5V, I_D=5.0A$
- $R_{DS(ON)}=35m\Omega @V_{GS}=2.5V, I_D=4.0A$
- $R_{DS(ON)}=55m\Omega @V_{GS}=1.8V, I_D=1.0A$



■ Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 10	
Continuous Drain Current $T_J=125^{\circ}C$	I_D	5.0	A
Pulsed Drain Current	I_{DM}	15	
Power Dissipation	P_D	1.25	W
Thermal Resistance.Junction- to-Ambient	R_{thJA}	100	$^{\circ}C/W$
Junction Temperature	T_J	150	$^{\circ}C$
Storage Temperature Range	T_{stg}	-55 to 150	

SI2300 (K12300)

■ Electrical Characteristics Ta = 25℃

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	V _{GS} =0V, I _D =250μA	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V			1	μA
Gate-Body Leakage	I _{GSS}	V _{GS} =±10V, V _{DS} =0V			±100	nA
Gate Threshold Voltage *	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250μA	0.4	0.7	1.0	V
Drain- Source on-state Resistance *	R _{DS(on)}	V _{GS} =4.5V, I _D =5.0A		20	25	mΩ
		V _{GS} =2.5V, I _D =4.0A		27	35	mΩ
		V _{GS} =1.8V, I _D =1.0A		39	55	mΩ
Forward Transconductance *	g _{FS}	V _{DS} =5V, I _D =5A	5			S
Input Capacitance	C _{ISS}	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz		887		pF
Output Capacitance	C _{OSS}			144		pF
Reverse Transfer Capacitance	C _{RSS}			115		pF
Turn-On Delay Time	t _{D(on)}	V _{DD} =10V, I _D =1A, V _{GS} =4.5V, R _L =10Ω, R _{GEN} =6Ω		31.8		ns
Rise Time	t _r			14.5		ns
Turn-Off Delay Time	t _{D(off)}			50.3		ns
Fall Time	t _f			31.9		ns
Total Gate Charge	Q _g	V _{DS} = 10V, I _D = 3.5A, V _{GS} = 4.5V		16.8		nC
Gate-Source Charge	Q _{gs}			2.5		nC
Gate-Drain Charge	Q _{gd}			5.4		nC
Drain-Source Diode Forward Current *	I _S				1.25	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =1.25A		0.825	1.2	V

* Pulse Test:Pulse Width≤300 μs,Duty Cycle ≤2%

■ Marking

Marking	00A*
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SI2300 (KI2300)

■ Typical Characteristics

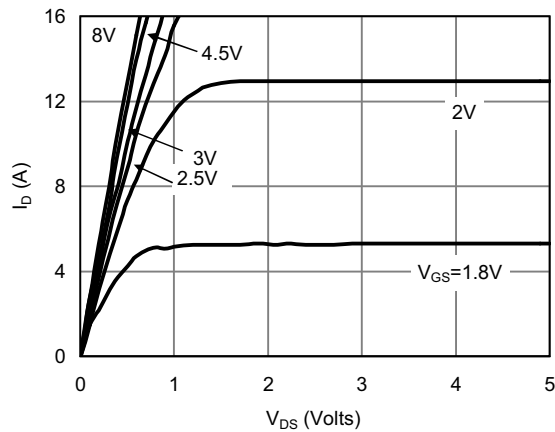


Fig 1: On-Region Characteristics

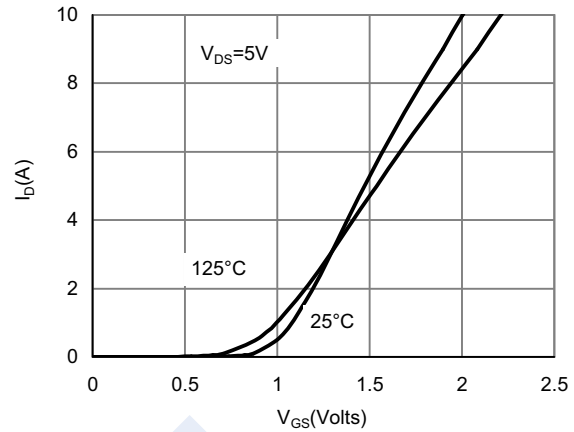


Figure 2: Transfer Characteristics

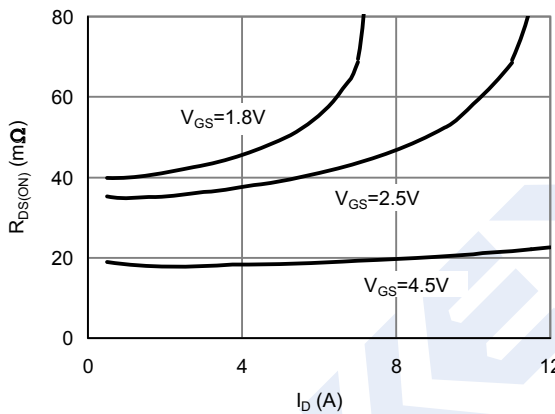


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

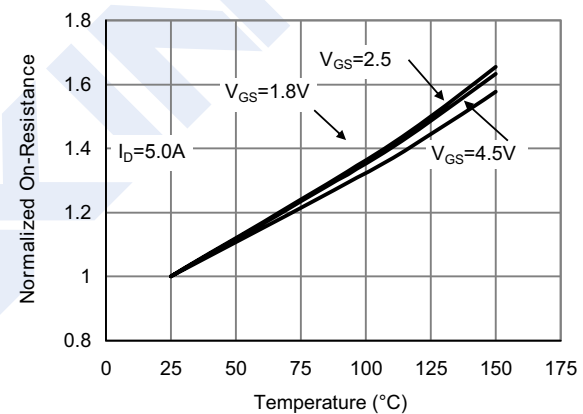


Figure 4: On-Resistance vs. Junction Temperature

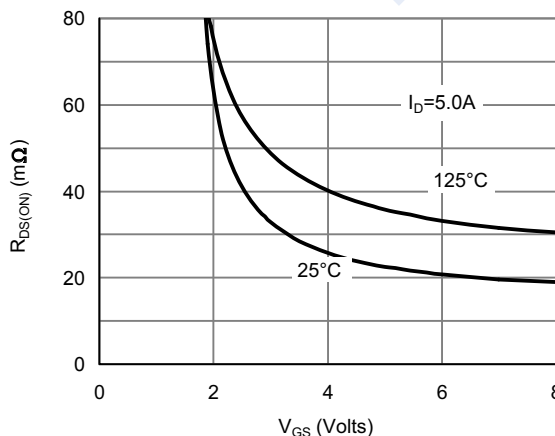


Figure 5: On-Resistance vs. Gate-Source Voltage

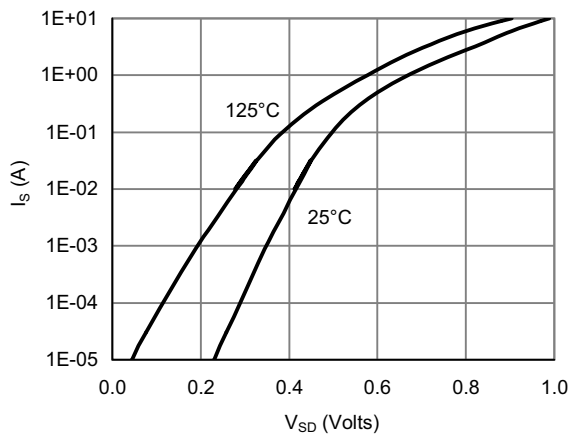


Figure 6: Body-Diode Characteristics